

Excellent Integrated System Limited

Stocking Distributor

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[Johanson Technology Inc.](#)
[2450DP15E5400E](#)

For any questions, you can email us directly:

sales@integrated-circuit.com

"High Frequency Ceramic Solutions"

2450 / 5400 MHz Diplexer (LPF / BPF) **P/N 2450DP15E5400**
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General Specifications

Part Number	2450DP15E5400			Input Power	3 Watts max.
Attenuation in Low Band Path	* 0.70 dB max. @ 2.4 ~ 2.5 GHz	20 dB min. @ 4.8 ~ 6.0 GHz	20 dB min. @ 7.2 ~ 7.5 GHz	Impedance	50 Ω
	* 1.60 dB max. @ 4.9 ~ 5.875 GHz	17 dB min. @ 1.8 ~ 2.5 GHz	20 dB typ. @ 10.3 ~ 10.7 GHz	Operating Temp	-40 to +85°C
Attenuation in High Band Path				Storage Temp	-40 to +85°C
				Reel Quantity	4000

Pass-band Return Loss In Both Bands	9.5 dB min.
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* Note: The I.L. parameters are based on probed & TRL cal'd measurement

Mechanical Dimensions

	In	mm
L	0.079 ± 0.004	2.00 ± 0.10
W	0.049 ± 0.004	1.25 ± 0.10
T	0.035 ± 0.004	0.90 ± 0.10
a	0.012 ± 0.004	0.30 ± 0.10
b	0.008 ± 0.004	0.20 ± 0.10
c	0.012 +.004/-0.008	0.30 +0.1/-0.2
g	0.014 ± 0.004	0.35 ± 0.10
p	0.026 ± 0.002	0.65 ± 0.05

Unit : mm

Terminal Configuration

No.	Function
1	Higher Freq. Port (P1)
2	GND
3	Lower Freq. Port (P3)
4	GND
5	Common Port (P2)
6	GND

Mounting Considerations

Mount these devices with brown mark facing up.
 Line width should be designed to provide 50Ω impedance matching characteristics.
 Units: mm

- Solder Resist
- Land
- Through-hole (φ0.3)

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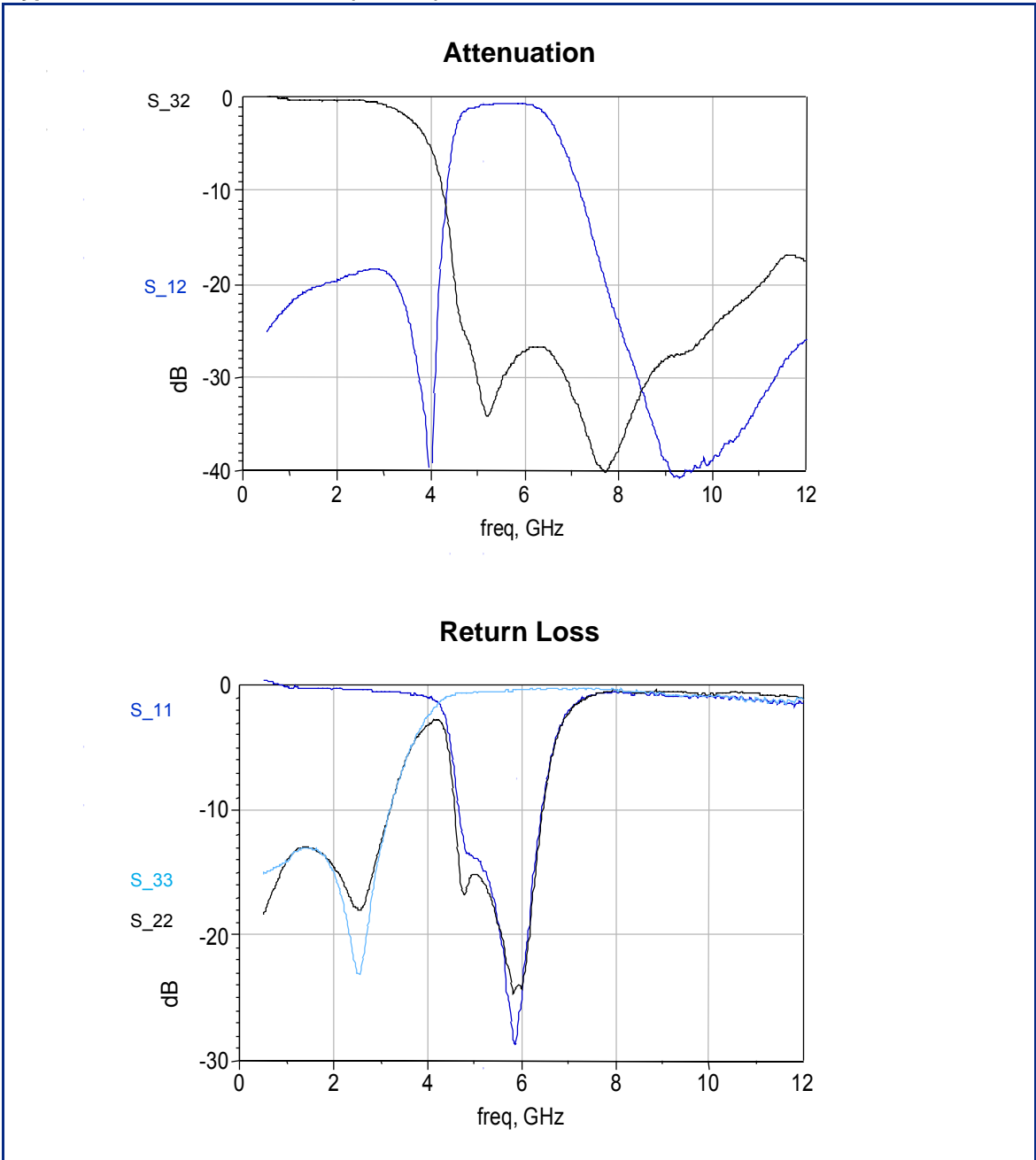
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Typical Electrical Performance (T=25°C)



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